



Product Change Notification

105663 - 00

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Product Change Notification

Change Notification #: 105663 - 00
Change Title: Intel® NetStructure™ MPCHC0001 14U, PCN 105663-00, FFF, Changes to Power Riser PBA, CDM Gasket, and 14-Slot filler panel.
Date of Publication: November 15, 2005

Type of Change Notification:
FFF - (Form-Fit-Function)

Key Characteristics of the Change:
Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Nov 21, 2005
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Description of Change to the Customer:

1. Change Power Riser PBA, remove extra mounting hole in board.
2. Removed 2 CDM Bay EMI Gaskets from chassis. Gasket causing distortion of gasket when CDM was installed. (This is a clarification to the previous -005 PCN that also had the gaskets removed due to a manufacturing deviation).
3. Added 14-Slot filler panel alternate assembly, this assembly has mounting hole paint masking on inner surfaces. Primary or alternate may be used.

Customer Impact of Change and Recommended Action:

1-3. No customer impact. Regulatory emissions test passed with CDM gaskets removed.”

Products Affected / Intel Ordering Codes:

System Products Table

Affected Product Code	Pre-Change MM#	Post-Change MM#	Pre-Change TA	Post-Change TA	Pre-Change Subassembly	Post-Change Subassembly
MPCHC0001 848998	848998	848998	C94926-005	C94926-006		

Reference Documents / Attachments:

Document: _____ **Location #:** _____

PCN Revision History:

Date of Revision: November 15, 2005	Revision Number: 00	Reason: Originally Published PCN
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